



To the Honorable Commissioner of 102237024 records the attached original documents or copy thereof.

1. Name of conveying party(ies):
Dong-Hyun Kim
Do-Hyun Cho
Woo-Dong Sung
Jin-Suk kim
Won-Suk Choi
Additional name(s) of conveying party(ies) attached? Yes No

9-24-02

2. Name and address of receiving party(ies):
Name: Samsung Electronics, Co., Ltd.
Internal Address: _____
Street Address: 416, Maetan-dong, Paldal-gu,
Suwon-city, Kyungki-do, Republic of Korea
City: _____ State _____ ZIP _____
Additional name(s) & address attached? Yes No

11046 U.S. PTO
10/25/02
09/24/02

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other _____
Execution Date: September 13, 2002

4. Application number(s) or patent number(s):
If this document is being filed together with a new application, the execution date of the application is: September 13, 2002
A. Patent Application No.(s) _____
B. Patent No.(s) _____
Additional numbers attached? Yes No 10/253023

5. Name and address of party to whom correspondence concerning document should be mailed:
Name: Anthony P. Onello, Jr.
Internal Address: MILLS & ONELLO LLP
Street Address: Eleven Beacon Street, Suite 605
City: Boston State MA ZIP 02108

6. Total number of applications and registrations involved 1
7. Total fee (37 CFR 3.41)..... \$40.00
 Enclosed
 Authorized to be charged to deposit account
8. Deposit Account Number: _____
(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature:
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.
09/30/2002 6TON11 00000004 10253023
01 FC:581 Anthony P. Onello, Jr. Reg. No. 38,572
Name of Person Signing Anthony P. Onello, Jr. Signature Anthony P. Onello, Jr. Date September 21, 2002
Total number of pages including cover sheet, attachments, and document 3

A S S I G N M E N T

We, Dong-Hyun Kim of Maronie 801, San #7-1, Nongseo-ri, Giheung-eup, Yongin-si, Gyeonggi-do, Republic of Korea; Do-Hyun Cho of 504-603, Shinjeongmaul, Pungdeokcheon-ri, Suji-eup, Yongin-si, Gyeonggi-do, Republic of Korea; Woo-Dong Sung of 325-1103, Daewoo Apt., Gwonseon-dong, Gwonseon-gu, Suwon-si, Gyeonggi-do, Republic of Korea; Jin-Suk Kim of Maronie 708, San #7-1, Nongseo-ri, Giheung-eup, Yongin-si, Gyeonggi-do, Republic of Korea; Won-Suk Choi of Maronie 801, San #7-1, Nongseo-ri, Giheung-eup, Yongin-si, Gyeonggi-do, Republic of Korea, having invented improvements in FLUID SAMPLING APPARATUS AND FLUID ANALYZER HAVING THE SAME, executed by us on even date herewith, for good and valuable consideration, receipt of which is hereby acknowledged from Samsung Electronics Co., Ltd., a Korean corporation having a place of business at 416, Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea (and hereinafter called the Assignee, which term shall include its successors and assigns), do hereby sell, assign and transfer unto the Assignee our entire right, title, and interest in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto, in and to and under said application (which term shall include hereinafter where the context so admits all divisional, continuing, reissue and other patent applications based thereon) and the inventions (which term shall include each and every such invention, or part thereof) therein described, and any and all patents and like rights of exclusion (including extensions thereof) of any country which may be granted on or for said inventions or on said application;

And for the same consideration We do also hereby sell, assign, and transfer unto the Assignee, all our rights under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, and all other treaties of like purpose in respect of said inventions and said application, and We do hereby authorize the Assignee to apply in our name or its own name or its designee for patents and like rights of exclusion on or for said inventions in all countries, claiming (if the Assignee so desires) the priority of the filing date of said application under the provisions of said Convention, Treaty or any such other Convention or Treaty;

And for the same consideration, We do hereby agree for ourselves and for our heirs, executors, and administrators, promptly upon request of the Assignee to execute and deliver without further compensation any power of attorney, assignment, original, divisional, continuing, reissue or other application or applications for patent or patents or like rights of exclusion of any country, or other lawful documents and any further assurances that may be deemed necessary or desirable by the Assignee, fully to secure to it said right, title, and interest as aforesaid in and to said inventions, applications, and said several patents and like rights of exclusion (including extensions thereof) or any of them, all, however, at the expense of the Assignee, its successors, or assigns;

And We do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and the corresponding Official of each country foreign thereto to issue to the Assignee, any and all patents and like rights of exclusion which may be granted in any country upon said United States application on or for said inventions;

And We do hereby covenant for ourselves and our legal representatives and agree with the Assignee, that We have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed our right, title, and interest in and to said inventions has not been otherwise encumbered by us, and that We have not executed and will not execute any instruments in conflict herewith.

First or Sole Inventor:

Signature: Dong-Hyun Kim
Dong-Hyun Kim

Date: 2002.09.13

Second Joint Inventor:

Signature: Do-hyun Cho
Do-Hyun Cho

Date: 2002.09.13

Third Joint Inventor:

Signature: Woo-Dong Sung
Woo-Dong Sung

Date: 2002.09.13

Fourth Joint Inventor:

Signature: Jin-Suk Kim
Jin-Suk Kim

Date: 2002.09.13

Fifth Joint Inventor:

Signature: Won-Suk Choi
Won-Suk Choi

Date: 2002.09.13

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